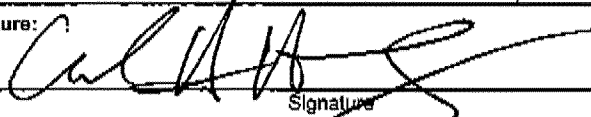


Form PTO-1595 (Rev. 03-11)
OMB No. 0651-0027 (exp. 03/31/2012)

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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies): Kwan-Ho Chan Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	2. Name and address of receiving party(ies) Name: <u>Kwan-Ho Chan</u> Internal Address: _____ Street Address: _____ 570 Research Park Way Suite 102 City: <u>North Logan</u> State: <u>Utah</u> Country: <u>United States of America</u> Zip: <u>84321</u> Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
3. Nature of conveyance/Execution Date(s): Execution Date(s): <u>April 29, 2011</u> <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Change of Name <input type="checkbox"/> Security Agreement <input type="checkbox"/> Joint Research Agreement <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License <input type="checkbox"/> Other _____	4. Application or patent number(s): <input type="checkbox"/> This document is being filed together with a new application. A. Patent Application No.(s) _____ B. Patent No.(s) <u>7,749,237</u> Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
5. Name and address to whom correspondence concerning document should be mailed: Name: <u>Charles H. Humkey</u> <u>LENER, DAVID, LITTENBERG,</u> <u>KRUMHOLZ & MENTLIK, LLP</u> Internal Address: Atty. Dkt.: OSTEONICS 3.0-750 CIP CCCC Street Address: <u>600 South Avenue West</u> City: <u>Westfield</u> State: <u>NJ</u> Zip: <u>07090</u> Phone Number: <u>908-654-5000</u> Fax Number: <u>908-654-7866</u> Email Address: <u>ataylor@ldlkm.com</u>	6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 1.21(h) & 3.41) \$ <u>40.00</u> <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title)
8. Payment Information Deposit Account Number <u>12-1095</u> Authorized User Name <u>Charles H. Humkey</u>	
9. Signature: <div style="text-align: center;">  _____ Signature </div> <div style="text-align: right;"> <u>November 29, 2011</u> Date </div> <div style="text-align: center; margin-top: 10px;"> <u>Charles H. Humkey - 60,702</u> Name of Person Signing </div> <div style="text-align: right; margin-top: 10px;"> Total number of pages including cover sheet, attachments, and documents: 4 </div>	

CH \$40.00 121095 774923

ASSIGNMENT

I,

Kwan-Ho Chan
(I) Name: 570 Research Park Way Suite 102
Address: North Logan, UT 84341

have invented a method and apparatus entitled SURGICAL REPAIR KIT AND ITS METHOD OF USE, hereinafter called the "invention." Preferred embodiments of said invention are disclosed in a United States patent application executed concurrently herewith by me and now identified as File No. CHAN-1 CIP CON, CHAN-1 CIP CON 5, CHAN-1 DIV, CHAN-1 CON 2, CHAN-1 CON 6, CHAN-1 CON 7, of the office of MedicineLodge, Inc. dba IMDS Co-Innovation, 124 South, 600 West, Logan, Utah 84321, and filed in the United States Patent and Trademark Office as Serial No.: 08/727,027 filed on 10/8/1996 and Serial No.: 09/811,953 filed on 3/19/2001, Serial No.: 08/727,025 filed on 10/8/1996 and Serial No.: 09/073,046 filed on 5/5/1998, Serial No.: 10/119,389 filed on 4/9/2002, Serial No.: 11/210,281 filed on 8/23/2005.

The Assignee, Kwan-Ho Chan., having a principal place of business at 570 Research Park Way Suite 102, North Logan, UT 84341, desires to secure the entire right, title and interest in said invention. In consideration of One Dollar (\$1.00) and other good and valuable consideration paid to me by the Assignee, the receipt and sufficiency of which I hereby acknowledge,

I HEREBY ASSIGN TO THE ASSIGNEE:

The entire right, title, and interest in said invention and in the above-identified United States patent application and in all provisionals, non-provisionals, divisions, continuations and continuations-in-part of said application, or reissues or extensions of letters patent or patents granted thereon, and in all corresponding applications filed in countries foreign to the United States, and in all patents issuing thereon in the United States and foreign countries.

The right to file foreign patent applications on said invention in its own name, wherever such right may be legally exercised, including the right to claim the benefits of the International Convention for such applications.

I hereby authorize and request the United States Commissioner for Patents and Trademarks, and such Patent Office officials in foreign countries as are duly authorized by their patent laws to issue patents, to issue any and all patents on said invention to the Assignee as the owner of the entire interest, for the sole use and benefit of the said Assignee, its successors, assigns and legal representatives.

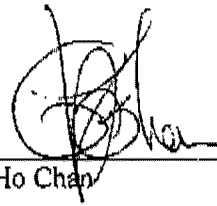
I hereby agree, without further consideration and without expense to me, to sign all lawful papers and to perform all other lawful acts which the Assignee may request of me to make this assignment fully effective, including, by way of example but not of limitation, the following:

Prompt execution of all original, divisional, substitute, reissue, and other United States and foreign patent applications on said invention, and all lawful documents requested by the Assignee to further the prosecution of any of such patent applications.

Cooperation to the best of my ability in the execution of all lawful documents, the production of evidence, nullification, reissue, extension, or infringement proceedings involving said invention.

This assignment and agreement shall be binding upon my heirs and legal representatives.

DATED 29 April 2011 ^{ce}



Kwan-Ho Chan